



- Designed for European 868.95 MHz Transmitters
- Variable Desiration
- · Very Low Series Resistance
- Quartz Stability
- Complies with Directive 2002/95/EC (RoHS)
- Tape and Reel Standard per ANSI/EIA-481
- Moisture Sensitivity Level: 1
- AEC-Q200 Qualified

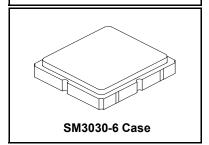
The RO3156E-3 is a true one-port, surface-acoustic-wave (SAW) resonator in a surface-mount ceramic case. It provides reliable, fundamental-mode, quartz frequency stabilization of fixed-frequency transmitters operating at 868.95 MHz.This SAW is designed specifically for remote-control and wireless security transmitters operating under ETSI EN 300 220.

#### **Absolute Maximum Ratings**

Absolute maximum ratings				
Rating	Value	Units		
Input Power Level	0	dBm		
DC Voltage	12	VDC		
Operating Temperature Range	-40 to +85	°C		
Soldering Temperature, 10 seconds / 5 cycles maximum	+260	°C		

# **RO3156E-3**

## 868.95 MHz SAW Resonator



#### **Electrical Characteristics**

Characteristic		Sym	Notes	Minimum	Typical	Maximum	Units
Frequency, +25 °C		f <sub>C</sub>		868.880		869.020	MHz
Tolerance from 868.95 MHz		$\Delta f_{C}$				±70	kHz
Insertion Loss		IL			1.2	2.0	dB
Quality Factor	Unloaded Q	Q <sub>U</sub>			6700		
	$50\Omega$ Loaded Q	$Q_L$			800		
Temperature Stability	Turnover Temperature	T <sub>O</sub>		10	25	40	°C
	Turnover Frequency	f <sub>O</sub>			f <sub>C</sub>		kHz
	Frequency Temperature Coefficient	FTC			0.032		ppm/°C <sup>2</sup>
Frequency Aging	Absolute Value during the First Year	fA			<±10		ppm/yr
DC Insulation Resistance between Any Two Terminals				1.0			MΩ
RF Equivalent RLC Model	Motional Resistance	$R_{M}$			14.1		Ω
	Motional Inductance	$L_M$			17.2		μΗ
	Motional Capacitance	C <sub>M</sub>			2.0		fF
	Shunt Static Capacitance	Co			2.3		pF
Test Fixture Shunt Inductance		L <sub>TEST</sub>			14.6		nH
Lid Symbolization: Y = Year, WW = Week, S = Shift					949, <u>YWWS</u>		
Standard Reel Quantity	Reel Size 7 Inch			500 Pieces / Reel			
	Reel Size 13 Inch			3000 Pieces / Reel			

# CAUTION: Electrostatic Sensitive Device. Observe precautions for handling. NOTES:

- 1. The design, manufacturing process, and specifications of this device are subject to change.
- 2. US or International patents may apply.
- 3. RoHS compliant from the first date of manufacture.

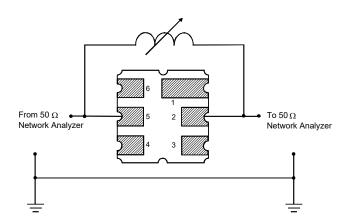
#### **Electrical Connections**

The SAW resonator is bidirectional and may be installed with either orientation. The two terminals are interchangeable and unnumbered. The callout NC indicates no internal connection. The NC pads assist with mechanical positioning and stability. External grounding of the NC pads is recommended to help reduce parasitic capacitance in the circuit.

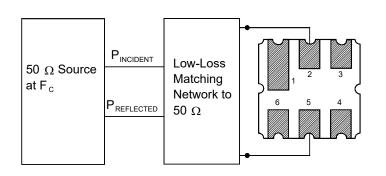
Pin	Connection		
1	NC		
2	Terminal		
3	NC		
4	NC		
5	Terminal		
6	NC		

#### **Typical Test Circuit**

The test circuit inductor,  $L_{TEST}$ , is tuned to resonate with the static capacitance,  $C_O$ , at  $F_C$ .

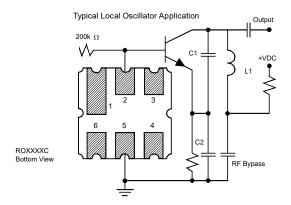


#### **Power Test**

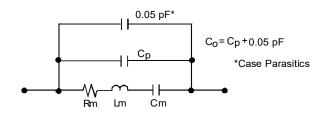


#### **Typical Application Circuits**

Typical Low-Power Transmitter Application  $\begin{array}{c} \text{Modulation} \\ \text{Input} \\ \text{ROXXXXC} \\ \text{Bottom View} \\ \end{array}$ 

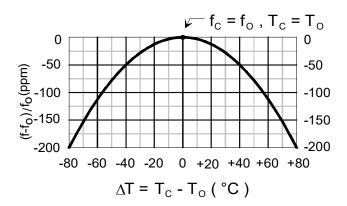


#### **Equivalent LC Model**



#### **Temperature Characteristics**

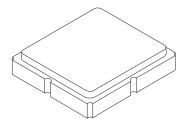
The curve shown on the right accounts for resonator contribution only and does not include LC component temperature contributions.

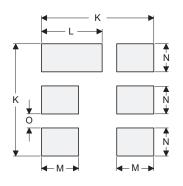


# **SM3030-6 Case**

# 6-Terminal Ceramic Surface-Mount Case 3.0 X 3.0 mm Nominal Footprint







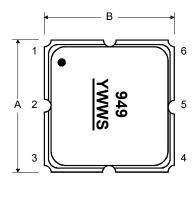
**PCB Footprint Top View** 

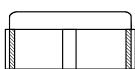
Dimension mm		Inches				
Dilliension	Min	Nom	Max	Min	Nom	Max
Α	2.87	3.00	3.13	0.113	0.118	0.123
В	2.87	3.00	3.13	0.113	0.118	0.123
С	1.12	1.25	1.38	0.044	0.049	0.054
D	0.77	0.90	1.03	0.030	0.035	0.040
E	2.67	2.80	2.93	0.105	0.110	0.115
F	1.47	1.60	1.73	0.058	0.063	0.068
G	0.72	0.85	0.98	0.028	0.033	0.038
Н	1.37	1.50	1.63	0.054	0.059	0.064
I	0.47	0.60	0.73	0.019	0.024	0.029
J	1.17	1.30	1.43	0.046	0.051	0.056
K		3.20			0.126	
L		1.70			0.067	
M		1.05			0.041	
N		0.81			0.032	
0		0.38			0.015	

#### **Case Materials**

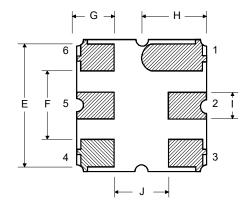
Materials			
Solder Pad Plating	0.3 to 1.0 μm Gold over 1.27 to 8.89 μm Nickel		
Lid Plating	2.0 to 3.0 µm Nickel		
Body	Al <sub>2</sub> O <sub>3</sub> Ceramic		
	Pb Free		

## **Top View**





### **Bottom View**



← D →

#### **Recommended Reflow Profile**

- 1. Preheating shall be fixed at 150~180°C for 60~90 seconds.
- 2. Ascending time to preheating temperature 150°C shall be 30 seconds min.
- 3. Heating shall be fixed at 220°C for 50~80 seconds and at 260°C +0/-5°C peak (10 seconds).
- 4. Time: 5 times maximum.

